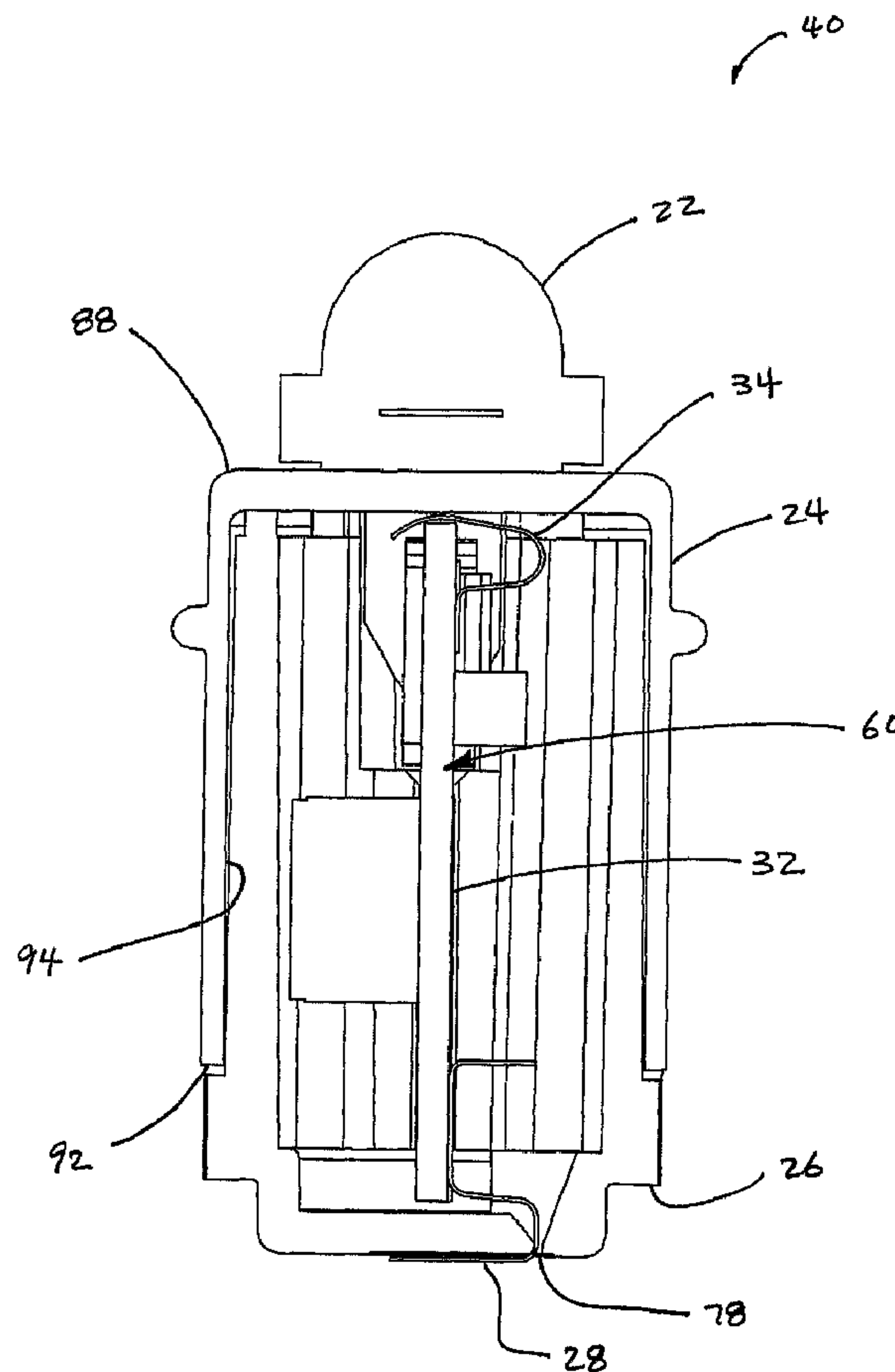




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(54) Title: IMPROVED LED MODULE



(57) Abrégé/Abstract:

An improved LED module that is thermally self-stabilizing, and that is able to be retrofitted into an existing flashlight is provided. In one embodiment, the LED module includes a light emitting diode, an amplifying circuit and a microchip. The amplifying circuit



(57) **Abrégé(suite)/Abstract(continued):**

includes a temperature sensing device to sense heat from the light emitting diode. The output of the amplifying circuit is input to the microchip which output to a switching device that regulates energy that is delivered to the light emitting diode. The switching device may be part of a boosting circuit, a bucking circuit or an inverting circuit.

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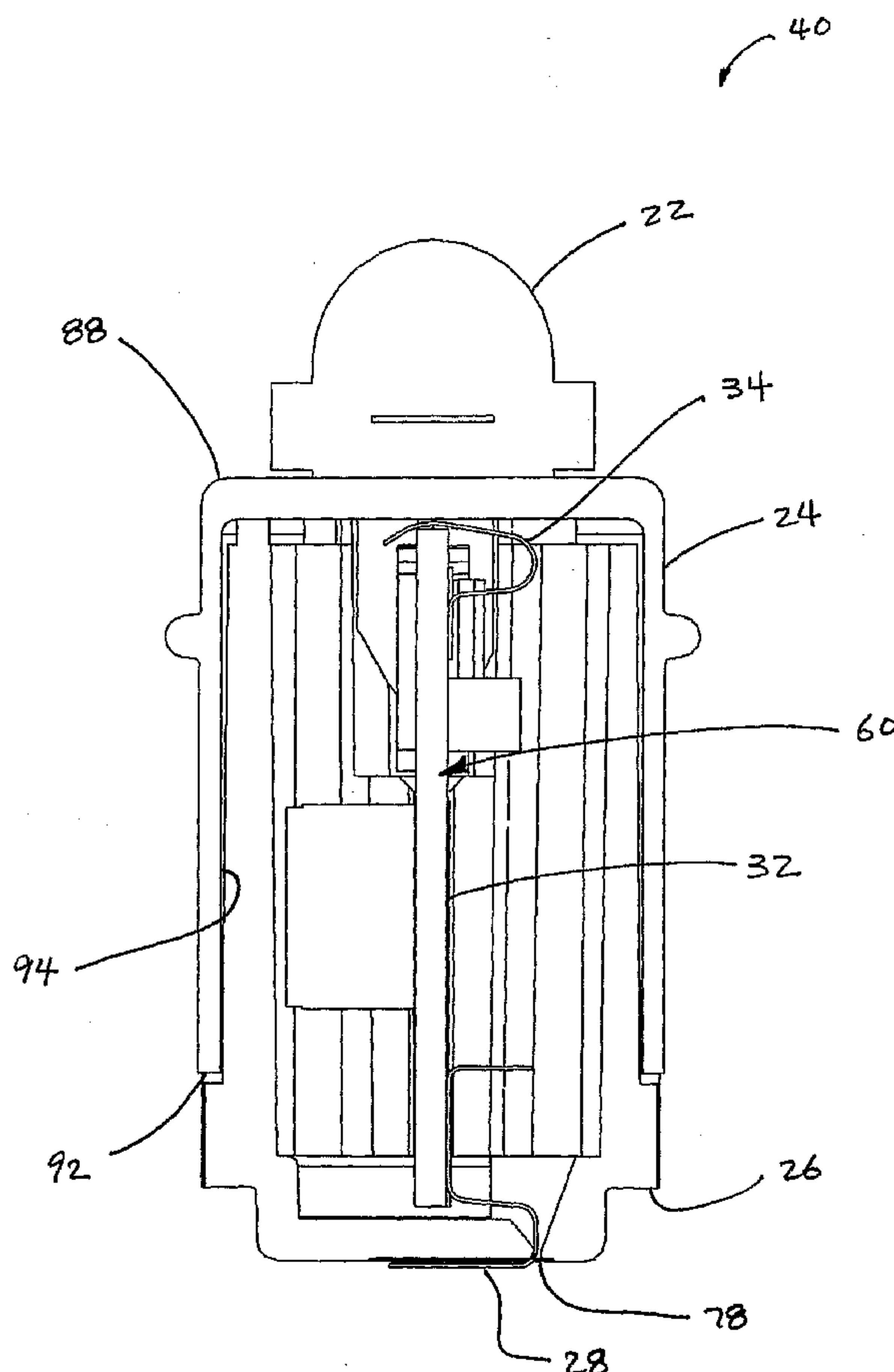
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(54) Title: SPECIFICATION IMPROVED LED MODULE



(57) Abstract: An improved LED module that is thermally self-stabilizing, and that is able to be retrofitted into an existing flashlight is provided. In one embodiment, the LED module includes a light emitting diode, an amplifying circuit and a microchip. The amplifying circuit includes a temperature sensing device to sense heat from the light emitting diode. The output of the amplifying circuit is input to the microchip which output to a switching device that regulates energy that is delivered to the light emitting diode. The switching device may be part of a boosting circuit, a bucking circuit or an inverting circuit.

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SPECIFICATION
IMPROVED LED MODULE

Field of the Invention

The field of the present invention relates to a lighting module including a
5 light emitting diode (LED), and pertains particularly to an energy regulating,
thermally stable LED based module for use in hand held portable lighting devices,
such as flashlights.

Background Of The Invention

LEDs have been used in various applications including illuminating
10 watches, transmitting information from remote controls, and forming images on
jumbo television screens. More recently, LEDs have been used in portable
lighting devices (such as flashlights), because, among other things, LEDs can last
longer, produce light more efficiently, and can be more durable than incandescent
lamps commonly used in conventional flashlights. Moreover, because flashlights
15 that use incandescent lamps dominate the field, LED modules (a module that
uses an LED as its light source) have been designed that can be retrofitted into
existing flashlights.

A problem with simply replacing an incandescent lamp of an existing
flashlight with an LED module, without more, is that it fails to operate the LED at
20 its potential lighting capacity under a thermally stable condition.

It is known that LEDs produce more light with increased forward current. In
situations where available voltage is abundant, the LED may be driven close to its
maximum forward current value to produce more light. However, where the
available voltage is limited or depletes over time, such as in the case of a battery
25 powered flashlight, delivering a forward current close to the LED's maximum value
may not be possible. A similar concern exists if the battery or batteries contained
in an existing flashlight provides too much voltage, thereby delivering a forward
current above the LED's maximum value, which will result in damage to the LED.

Another problem with simply replacing an incandescent lamp of an existing
30 flashlight with an LED module is that it fails to address the thermal consequences
associated with LEDs. Although LEDs produce light more efficiently than their
incandescent counterparts, LEDs generate significantly more heat. Therefore,
effective dissipation of heat is needed to maintain the LED temperature within its

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design limits. One effective way of dissipating heat generated by a light source in a flashlight is disclosed in a co-pending application publication 20060039139 entitled Improved LED Flashlight, filed August 20, 2004.

However, in the case of an LED module that is designed for retrofit, the existing flashlight into which the LED module is used may not be able to sufficiently dissipate the increased heat that is produced by the LED. Most LEDs have projected life and lumen capacity that is conditioned on maintaining a prescribed LED operating temperature. If this temperature is not maintained, the life and/or the strength of the light generated by the LED diminishes. Accordingly, if the existing flashlight into which the LED module is retrofitted is insufficient in this regard, the LED module itself must self-control the amount of heat that the LED generates to ensure that the LED or the electronics that may control the LED are not damaged.

Existing LED modules have attempted to address the thermal dissipation problem by limiting the current delivered to the LED to a continuous value at a safe level much below its potential light emitting capacity. However, such an approach makes inefficient use of the LED's lighting capacity and the LED's full lighting potential is never achieved.

Summary Of The Invention

The present invention involves a lighting module that is energy regulating and thermally self-stabilizing, and that is able to be retrofitted into an existing flashlight.

In one embodiment, the lighting module includes an LED, an amplifying circuit and a microchip. The amplifying circuit has a thermistor arranged to sense heat from the LED. The microchip is coupled to the amplifying circuit and a switching device to regulate the energy that is delivered to the LED. The switching device may be part of a boosting circuit, a bucking circuit or an inverting circuit.

[In a second embodiment, the lighting module includes a conductive housing, an LED, and a circuit board. The circuit board includes a module circuit that is electrically coupled to the LED. The circuit is at least partially contained within the cavity of the housing and also has a thermistor to sense heat from the LED. The thermistor may be coupled to an amplifying circuit. The gain of the amplifying circuit may adjust according to the temperature senses by the

thermistor. The output of the amplifying circuit may also be the input to a microchip.

[In another embodiment, the module can have a module circuit that is configured to regulate energy that is delivered to the LED based on the sensed temperature of the LED. In yet another embodiment, the LED module can have a module circuit that includes an energy regulating circuit and a thermal sensitive amplifying circuit.

Brief Description Of The Drawings

FIG. 1A is a circuit diagram of one embodiment of a main circuit of an electronic device.

FIG. 1B is a sectional view of a flashlight embodying the main circuit of FIG. 1A.

FIG. 2 is an enlarged sectional view of the forward section of the flashlight of FIG. 1B.

FIG. 3 is a circuit diagram of one embodiment of a module circuit.

FIG. 4A is a sectional view of an LED module implementing the module circuit of FIG. 3.

FIG. 4B is an exploded view of an LED module implementing the module circuit of FIG. 3.

FIG. 4C is a perspective view of an LED module implementing the module circuit of FIG. 3.

FIG. 5 is a circuit diagram of a second embodiment of a module circuit.

FIG. 6 is a circuit diagram of a third embodiment of a module circuit.

Detailed Description Of Preferred Embodiments

Turning now to the drawings, as shown in FIG. 1A, a schematic depiction of one embodiment of a main circuit 70 of an electronic device includes a power source 2, a main switch 4, and an LED module 40. Energy from the power source 2 preferably drives the LED module 40, and the main switch 4 controls the energy that is delivered to the LED module 40. In one embodiment of the present invention, the main switch 4 simply allows or disrupts the available energy from the power source 2 to reach the LED module 40.

Referring to FIG. 1B, the main circuit 70 is shown in one embodiment of a flashlight 10. The flashlight 10 includes a barrel 12, a tailcap assembly 20, a head assembly 30, the LED module 40, and a main switch assembly 50. In the

embodiment illustrated, the barrel 12 encases two batteries 14, 15. The head assembly 30 and the LED module 40 are preferably disposed about the forward end of the barrel 12; the tailcap assembly 20 is preferably disposed to enclose the aft end of the barrel 12; and the main switch assembly 50 is preferably interposed
5 between the LED module 40 and batteries 14, 15.

In the illustrated embodiment, the batteries 14, 15 serve as the power source 2 of the main circuit 70. In a preferred embodiment, the batteries 14, 15 are alkaline type dry cell batteries. However, other suitable portable sources of energy may be used including rechargeable type batteries, such as Lithium-Ion,
10 Nickel Metal Hydride or Nickel-Cadmium cells.

The barrel 12 preferably has a length suitable to contain a desired number of batteries. In the illustrated embodiment, the barrel 12 has a length suitable for containing two batteries 14, 15. However, barrels having various lengths are contemplated herein to receive one or more batteries.

15 In the illustrated embodiment, the main switch assembly 50 serves as the main switch 4 of the main circuit 70. Referring to FIG. 2, energy from the batteries 14, 15 to the main switch assembly 50 preferably flows through a contact button 16 that is interposed between the forwardmost battery 14 and the main switch assembly 50.

20 The main switch assembly 50 preferably includes a user interface 68, a plunger 72, a snap dome 73, a main switch circuit board 74, a main switch battery contact 75, a main switch module contact 76, and a switch housing 77. In the illustrated embodiment, the center electrode of the forwardmost battery 14 is electrically coupled to the main switch battery contact 75 through the contact
25 button 16; the main switch battery contact 75 is electrically coupled to the main switch circuit board 74; and the main switch circuit board 74 is electrically coupled to the main switch module contact 76.

The main switch assembly 50 is preferably a momentary switch. When the user interface 68 is depressed, the plunger 72 pushes the snap dome 73 into
30 contact with a select portion of the main switch circuit board 74. This momentary contact is received as a signal to the switch circuit board 74 which in turn passes or disrupts the energy flow from the batteries 14, 15 to the main switch module contact 76. In this way, the main switch assembly 50 can turn the flashlight 10 on or off. The main switch circuit board 74 may additionally include circuitry suitable
35 for providing functions to the flashlight 10, such as for example, flashing, dimming or strobing by affecting the current that is delivered to a light source or, in the

illustrated embodiment, the LED module 40. Other functions may include an electronic game, a global positioning transponder, a digital compass, or other commercially desirable functions.

Still referring to the illustrated embodiment of FIG. 2, the main switch battery contact 75 and module contact 76 are configured to include curved springs or biasing elements that bear against the contact button 16 and spring 17, respectively. By arranging the curved spring portion of the main switch battery contact 75 and module contact 76 against the switch housing 77 such that the spring forces generated by the contacts 75, 76 are transferred to the switch housing 77, the main switch circuit board 74 is advantageously protected from, for example, batteries 14, 15 shifting and pressing on the main switch assembly 50. In this way, an effective electrical connection can be maintained by the biasing elements while protecting sensitive components, such as the main switch circuit board 74.

Although the main switch assembly 50 as described above provides a configuration for turning the flashlight 10 on and off, other suitable switches are available for serving this function, such as a simple mechanical switch. However, the main switch assembly 50 as disclosed herein advantageously provides a flexible configuration for adding, revising or deleting functions from the flashlight 10. Also, the main switch assembly 50 as described avoids high oxidation problem between contacts often experienced with mechanical switches.

Still referring to FIG. 2, the current flowing from the main switch assembly 50 to the LED module 40 is preferably achieved through the spring 17 and a receptacle 18, (which is disposed about the forward end of the spring 17,) that are electrically connected to the main switch module contact 76 on one end and to the LED module 40 on the other end. The spring 17 urges the receptacle 18 toward the positive contact of the LED module 40. In the illustrated embodiment, the current flows into the LED module 40 at its positive contact 28, and flows out of the LED module 40 at its outer housing 24. The electrical energy then preferably passes through conductive means to the barrel 12, through the tailcap assembly 20; and returns to the negative end of the aftmost battery 15. In this way, the main circuit 70 of the flashlight 10 is completed.

The barrel 12 is preferably made from a conductive material, preferably aluminum, so that it may serve as part of the current path of the main circuit 70 between the LED module 40 and the power source 2, i.e., batteries 14, 15. However, the barrel 12 may alternatively be made of non-conductive material,

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such as plastic or rubber, and may include a current path by having a conductive sleeve within a non-conductive barrel to serve as part of the current path. Such a sleeve is described in U.S. patent Nos. 4,656,565 and 4,851,974 to Anthony Maglica. In an alternate embodiment,

5 a conductive strip within the barrel can serve as part of the current path. Such a strip is shown in U.S. Patent No. 6,585,391.

Referring to FIG. 1B, the tailcap assembly 20 preferably includes a cap spring 6 and a cap 8. The tail cap assembly 20 may be part of the current path between the LED module 40 and the power source 2, and may receive the current
10 passing through the barrel 12. In one embodiment, the electrical path from the barrel 12 may be to the cap 8; to the cap spring 6, and then to the negative contact of the aftmost battery 15. Alternatively, the electrical path may bypass the cap 8 and flow directly from the barrel 12 to the battery 15 through the cap spring 6. Another embodiment may provide an electrical path that bypasses the tailcap
15 assembly 20 altogether and electrically connect the barrel 12 to the battery. A tailcap assembly 20 having a cap spring 6 provides an effective configuration for maintaining a spring assisted electrical connection between the components contained in the flashlight 10.

As shown in FIG. 1B and FIG. 2, the head assembly 30 includes a head 31,
20 a reflector 33, a lens 35 and a cap 39. The reflector 33 and lens 35 are interposed between the head 31 and the cap 39 as illustrated in FIG. 2. The reflector 33 preferably includes a reflective parabolic surface to reflect the light emanating from the LED module 40. The head assembly 30 may be secured to the barrel 12 by thread engagement.

25 As already mentioned, and schematically depicted in FIG. 1A, the current from the power source 2 flows into the LED module 40 at its positive contact 28 and flows out of the LED module 40 from its outer housing 24. Referring to FIG. 3, a schematic depiction of one embodiment of the LED module 40 according to the present invention generally includes an LED lamp 22 and a module circuit 38.

30 Referring to FIG. 3, 4A, 4B and 4C, the LED lamp 22 is preferably commercially available and includes an LED and LED leads 82, 83 to which the module circuit 38 connects. Typically, LED's are rated according to permissible operating conditions. For example, an LED may be limited to a maximum forward current rating of 1000 mA, and a maximum LED junction temperature of 135°C.

35 An objective of the present invention is to have the LED lamp 22 produce as much light as possible, for as long as possible, without damaging the LED lamp

22 or the electronics that make up the LED module 40. This objective is achieved by regulating the current that flows to the LED lamp 22 and monitoring the heat that is generated from the LED lamp 22. In a preferred embodiment, a temperature sensing device is disposed within the LED module 40 to monitor the conditions surrounding the LED. When an undesirable increase in temperature is sensed, the current delivered to the LED lamp 22 may be decreased to protect the LED and the electronics from heat damage. When an undesirable decrease in temperature is sensed, the current delivered to the LED lamp 22 may be increased to cause the LED lamp 22 to produce more light.

Referring to Fig. 3, a first embodiment of the module circuit 38 preferably includes a controlled voltage boosting circuit 44, a thermal sensitive amplifying circuit 52, and a sense resistor 48. The voltage boosting circuit 44 is controlled because it includes feedback to adjust its output. The boosting circuit 44 is useful in situations where the power source 2 driving the LED module 40 has a maximum potential that is below what is needed to deliver the desired forward current. For example, in a case where flashlight 10 includes two alkaline type dry cell batteries arranged in series, it is generally known that the two batteries will have an operating range of 1.8 Volts to 3.0 Volts. But 3.5 Volts may be needed to deliver a forward current that is closer to the LED's maximum forward current rating. In such a situation, the boosting circuit 44 steps up the available voltage to approximately 3.5 Volts so that the desired forward current may be delivered to the LED lamp 22. The boosting circuit 44 also serves to maintain the desired forward current as the voltage level of the batteries diminish over time.

In a preferred embodiment, the boosting circuit 44 is a switching regulator. Referring to FIG. 3, the boosting circuit 44 includes a microchip 46, a switching MOSFET 54, an inductor 58, a capacitor 59, and a diode 61. The microchip 46 controls the switching duty cycle of the switching MOSFET 54. As illustrated, the switching MOSFET 54, inductor 58, the capacitor 59, and the diode 61 are arranged in a manner commonly known to those skilled in the art to form a boost converter. The microchip 46 receives feedback by way of the thermal sensitive amplifying circuit 52. When the feedback is outside a specified regulation range, the microchip adjusts the MOSFET's duty cycle until the regulation range is met.

The boosting circuit 44 described herein may be composed of other suitable circuitry or devices that step up the input voltage. For example, instead of having the inductor 58 as the energy-storage element of the boosting circuit 44, other suitable energy storage elements, such as a capacitor or a transformer, may

also be used. Also, other suitable switching devices, such as a transistor, may be used instead of the switching MOSFET 54.

Still referring to FIG. 3, an electrical path connects the output of the boosting circuit 44 to the first LED reception contact 36; and the first LED
5 reception contact 36 is coupled to the first LED lead 82. The current flows out of the LED lamp 22 through the second LED lead 83, which is coupled to the second LED reception contact 37. The main power path is through the sense resistor 48 and to ground contact 34. The sense resistor 48 is used to measure the current that is passing through the LED lamp 22, and the voltage measured across the
10 sense resistor 48 serves as feedback to the microchip 46. Preferably, the sense resistor 48 is very small to minimize power waste. In a preferred embodiment, the sense resistor 48 has a value of 0.10 ohms.

Because the sense resistor 48 is very small, the voltage that forms across the sense resistor 48 is also very small. Therefore, before the sense resistor
15 voltage is fed back to the microchip 46, it is amplified by the amplifier circuit 52.

The thermal stabilizing aspect of the present invention is implemented in the thermal sensitive amplifying circuit 52. Still referring to FIG. 3, the amplifying circuit 52 includes an operational amplifier 62, a first resistor 64, a second resistor 66, and a thermistor 56. The thermistor 56 is arranged in parallel with the second
20 resistor 66. As configured, it is understood by those skilled in the art that the first resistor 64, the second resistor 66 and the thermistor 56, in combination, define the gain of the amplifying circuit 52. The thermistor 56 is a temperature responsive resistor that changes its resistance according to the sensed temperature. Therefore, as the sensed LED lamp 22 temperature varies, the gain
25 of the amplifying circuit 52 varies.

In a preferred embodiment, the thermistor 56 has a negative resistance/temperature coefficient. Accordingly, when the temperature of the LED module 40 increases, the thermistor resistance decreases, and the gain of the amplifier circuit 52 increases. With the microchip feedback above the regulation
30 range, the microchip 46 decreases the duty cycle of the switching MOSFET 54 and reduces the current that is delivered to the LED lamp 22. In this way, the temperature effects of the LED lamp 22 can be monitored and prevented from damaging the LED or the controlling electronics. In a preferred embodiment, the microchip 46 is configured to regulate the current delivered to the LED lamp 22 to
35 approximately between 875 mA and 930 mA at a thermistor sensed temperature

of between 20°C to 30°C; between 880 mA and 910 mA at between 23°C to 27°C; and substantially 900 mA at 25°C.

At a higher temperature, the microchip 46 is preferably configured to regulate the current delivered to the LED lamp 22 to approximately between 330
5 mA and 450 mA at a thermistor sensed temperature of between 80°C to 100°C; 330 mA to 370 mA at 90°C to 100°C; and substantially 330 mA at 100°C.

Although these temperature/current ranges have been found to effectively present an LED from heat damage, the current invention should not be viewed to be limited to any specific temperature/current range. Rather, the instant invention
10 is directed to an LED module that operates the LED at its potential, and that is thermally self-stabilizing.

Although a thermistor having a negative resistance/temperature coefficient is disclosed herein, a thermistor having a positive resistance/temperature coefficient may also be used. Moreover, other suitable temperature sensing
15 devices, such as a voltage output temperature sensor, may be used instead of a thermistor.

Further, a suitable microchip 46 for this application may be a processor, a microprocessor, a controller, an integrated circuit, an ASIC, or other devices known to those skilled in the art.

20 In this way, the LED module 40 allows the initial operation of the flashlight to be at a high power output, and to deliver more light, while protecting the electronics from heat damage. Without the thermal stabilizing capability as described and illustrated above, driving the LED lamp 22 at 750 mA may result in heat damage to the LED. Operating the LED lamp 22 at lower current will result in
25 less light.

Having now described the schematic depiction of one embodiment of the LED module 40, a preferred physical implementation of the LED module 40 is illustrated in Figs. 4A, 4B, and 4C. The LED module 40 includes the LED lamp 22, the outer housing 24, a circuit assembly 60, and a holder 26. The circuit
30 assembly 60 is preferably held in the holder 26; the holder 26 is preferably arranged within the outer housing 24; and the LED lamp 22 is preferably disposed on the forward end of the holder 26.

Preferably, the outer housing 24 is made from a conductive material. In the illustrated embodiment, the outer housing 24 is generally a receptacle including a
35 first end 88, a second end 92 and a cavity 94. The cavity 94 may include features, such as slots, to receive and align holder 26 therein.

In a preferred embodiment, the circuit assembly 60 includes a circuit board 32, the positive contact 28, a negative contact 34, and first and second LED reception contacts 36, 37. Preferably, the components of the module circuit 38, including the thermistor 56, are mounted to the circuit board 32 with necessary traces printed thereon. The circuit assembly 60 is configured to be held in the holder 26. Referring to Fig. 4A, the positive contact 28 of the circuit assembly 60 preferably extends through an opening 78 on the aft end of the holder 26. The positive contact 28 is preferably folded over to bear against the aft end of the holder 26 for support. The negative contact 34 of the circuit assembly 60 is preferably disposed about the forward end of the circuit board 32 and arranged to electrically connect to the outer housing 24. Arranged this way, the circuit components mounted on the circuit board 32 is advantageously protected from mechanical forces, such as from the spring 17 and receptacle 18.

Referring to FIGS. 4B and 4C, LED leads 82, 83 extend through openings about the first end 88 of the outer housing 24, and electrically couple to the first and second LED reception contacts 36, 37 of the circuit assembly 60. Preferably, the electrical connection between the LED reception contacts 36, 37 and the LED lead 82, 83 are mechanical, or particularly, by friction, to ease manufacturing and production costs. However, any suitable electrical connection methods, such as soldering, can be used.

Arranged as described, the components of the module circuit 38 are mounted to the circuit board 32 and contained in the LED module 40. The physical arrangement of the LED module 40 as just described is one suitable way to implement the module circuit 38 and operate the LED lamp at its lighting potential while protecting the electronics from heat damage by monitoring the heat generated from the LED and decreasing the current flowing thereto if necessary. The external dimensions of the LED module 40, and particularly the outer housing 24, is preferably consistent with PR type light bulbs. Having such an external dimension facilitates retrofitting the LED module 40 as described herein into existing flashlights that receive incandescent PR type light bulbs. However, the present invention as described herein is not limited by the external dimension or features as illustrated. The benefits and advantages of an LED module that operates the LED at its potential, that is thermally self-stabilizing, and that is able to be retrofitting into an existing flashlight may be achieved through numerous external configurations.

The flow of energy through the flashlight 10, and particularly through the LED module 40, will now be described. Electrical current from the batteries 14, 15 flows through the main switch assembly 50 and into the LED module at the positive contact 28. The positive contact 28 is electrically connected to the module circuit 38 mounted on the circuit board 32 and the main power flows to the boosting circuit 44. The output of the boosting circuit 44 flows to the first LED reception contact 36, then to the LED lead 82 and through the LED. The electrical current flows out of the LED lamp 22 through the second LED lead 83, which is coupled to the second LED reception contact 37. The main power passes through the sense resistor 48 and to the negative contact 34 of the circuit assembly 60, while the sense resistor 48 voltage is directed to the thermal sensitive amplifying circuit 52.

The main power then passes through the sense resistor and to the negative contact 34 which is coupled to the outer housing 24. The outer housing 24 is coupled to the barrel 12, the tailcap assembly 20, and finally to the negative end of the aftmost battery 15 to complete the main circuit.

The sense resistor 48 voltage is amplified by the thermal sensitive amplifying circuit 52 according to a gain that is a function of the LED lamp 22 temperature. The output of the thermal sensitive amplifying circuit 52 is feedback to the microchip 46 which regulates the current that is delivered to the LED lamp 22 by adjusting the duty cycle of the switching MOSFET 54.

In a second embodiment of an LED module 40a, the power source 2 coupled to the LED module 40a may have a potential that is above what is needed to deliver the desired forward current. For example, in the instance where a flashlight includes four batteries arranged in series, it would have an operating range of 3.6 Volts to 6.0 Volts. In such an instance, the module circuit 38a preferably includes a controlled voltage bucking circuit 84 in place of a boosting circuit 44. Referring to Fig. 5, a schematic depiction of this second embodiment of the LED module 40a generally includes an LED lamp 22 and a module circuit 38a. The module circuit 38a includes a controlled voltage bucking circuit 84, the sense resistor 48, and the thermal sensitive amplifying circuit 52. The voltage bucking circuit 84 is controlled because it includes feedback to adjust its output. The bucking circuit 84 output drives the LED lamp 22, and receives the sense resistor 48 feedback through the thermal sensitive amplifying circuit 52.

Referring to FIG. 5, the bucking circuit 84 is preferably a buck regulator or a bucking circuit and includes a microchip 46a, a switching MOSFET 54a, an

inductor 58a, a capacitor 59a, and a diode 61a. These components are arranged in a manner commonly known to those skilled in the art to form a bucking circuit.

5 In a third embodiment of an LED module 40b, the power source 2 coupled to the LED module 40b may have a potential above what is needed to deliver the desired forward current during a first period of time, and a potential below what is needed during a second period of time. For example, if a flashlight is configured with three batteries arranged in series, its operating range would be 2.7 Volts to 4.5 Volts. In such an instance, the module circuit 38b preferably includes an controlled voltage inverting circuit 86 instead of the boosting circuit 44 or the
10 bucking circuit 84. Referring to Fig. 6, a schematic depiction of a third embodiment of the LED module 40b generally includes an LED lamp 22 and a module circuit 38b. The module circuit 38b includes a controlled voltage inverting circuit 86, the sense resistor 48, and the thermal sensitive amplifying circuit 52. The inverting circuit 86 is controlled because it includes feedback to adjust its
15 output. The inverting circuit 86 output drives the LED lamp 22, and receives the sense resistor 48 feedback through the thermal sensitive amplifying circuit 52.

Referring to FIG. 6, the inverting circuit 86 is preferably an inverting regulator or inverting circuit and includes a microchip 46b, a switching MOSFET 54b, an inductor 58b, a capacitor 59b, and a diode 61b. These components are
20 arranged in a manner commonly known to those skilled in the art to form a inverting circuit.

While various embodiments of an improved LED module and its respective components have been presented in the foregoing disclosure, numerous modifications, alterations, alternate embodiments, and alternate materials may be
25 contemplated by those skilled in the art and may be utilized in accomplishing the various aspects of the present invention. Thus, it is to be clearly understood that this description is made only by way of example and not as a limitation on the scope of the invention as claimed below.

Claims:

1. A lighting module for flashlights, said lighting module comprising:
a light emitting diode;
an amplifying circuit including a thermistor, said thermistor arranged to
5 sense heat from said light emitting diode; and
a microchip having an input and an output, said amplifying circuit coupled
to said input, said output coupled to a switching device that regulates energy
delivered to the light emitting diode.
2. A lighting module of claim 1, wherein said switching device is part of
10 a boosting circuit.
3. A lighting module of claim 1, wherein said switching device is part of
a bucking circuit.
4. A lighting module of claim 1, wherein said switching device is part of
an inverting circuit.
- 15 5. A lighting module of claim 1, wherein said switching device is a
MOSFET.
6. A lighting module of claim 1, wherein said microchip is configured to
operate the switching device such that 875 mA to 930 mA is delivered to the light
emitting diode when said thermistor senses between 20°C to 30°C.
- 20 7. A lighting module of claim 1, wherein said microchip is configured to
operate the switching device such that 880 mA to 910 mA is delivered to the light
emitting diode when said thermistor senses between 23°C to 27°C.
8. A lighting module of claim 1, wherein said microchip is configured to
operate the switching device such that substantially 900 mA is delivered to the
25 light emitting diode when said thermistor senses 25°C.

9. A lighting module of claim 1, wherein said microchip is configured to regulate the energy that is delivered to said light emitting diode by adjusting the switching duty cycle of said switching device.

5 10. A lighting module of claim 1, wherein said microchip is configured to operate the switching device such that 330 mA to 450 mA is delivered to the light emitting diode when said thermistor senses between 80°C to 100°C.

11. A lighting module of claim 1, wherein said microchip is configured to operate the switching device such that 330 mA to 370 mA is delivered to the light emitting diode when said thermistor senses between 90°C to 100°C.

10 12. A lighting module of claim 1, wherein said microchip is configured to operate the switching device such that substantially 330 mA is delivered to the light emitting diode when said thermistor senses 100°C.

13. A lighting module of claim 1, wherein said microchip is a microprocessor.

15 14. A lighting module of claim 1, wherein said microchip is an integrated circuit.

15. A lighting module of claim 1, wherein said microchip is energized by a power source, wherein the energy of said power source depletes over time.

20 16. A lighting module for a flashlight, said lighting module comprising:
a conductive housing including a first end, a second end, and a cavity;
a light emitting diode disposed on the first end of said conductive housing;
and

25 a circuit board including a module circuit electrically coupled to said light emitting diode, said circuit board at least partially contained within the cavity of said housing, said module circuit having a thermistor to sense heat from said light emitting diode.

17. A lighting module of claim 16, wherein said thermistor is coupled to an amplifying circuit.

15

18. A lighting module of claim 16, wherein said module circuit is electrically coupled to said conductive housing.

19. A lighting module of claim 16, wherein said thermistor is coupled to an amplifying circuit, wherein the gain of the amplifying circuit adjusts according to the temperature sensed by said thermistor.

20. A lighting module of claim 19 further including a microchip configured to regulate energy flowing to said light emitting diode, wherein output of said amplifying circuit is input to said microchip.

21. A lighting module of claim 20, wherein said microchip is coupled to a boosting circuit.

22. A lighting module of claim 20, wherein said microchip is coupled to a bucking circuit.

23. A lighting module of claim 20, wherein said microchip is coupled to an inverting circuit.

24. An LED module for a flashlight comprising:
a conductive housing;
an LED disposed on one end of said housing; and
a module circuit contained in said housing electrically coupled to said LED, said module circuit configured to regulate energy that is delivered to the LED based on the sensed temperature of the LED.

25. An LED module of claim 24, wherein said module circuit includes a thermistor to sense the temperature of the LED.

26. An LED module of claim 24, wherein said thermistor has a negative resistance coefficient.

27. An LED module of claim 24, wherein said module circuit includes an amplifying circuit, wherein the gain of said amplifying circuit is a function of the sensed temperature of the LED.

28. An LED module of claim 27, wherein said module circuit includes a boosting circuit that is regulated according to the gain of said amplifying circuit.

29. An LED module of claim 27, wherein said module circuit includes a bucking circuit that is regulated according to the gain of said amplifying circuit.

5 30. An LED module of claim 27, wherein said module circuit includes a inverting circuit that is regulated according to the gain of said amplifying circuit.

31. An LED module comprising:
a conductive housing ;
an LED disposed on one end of said housing; and
10 a module circuit contained in said housing electrically coupled to said LED and to said conductive housing, said module circuit including an energy regulating circuit and a thermal sensitive amplifying circuit.

32. An LED module of claim 31, wherein said thermal sensitive amplifying circuit includes a temperature sensing device.

15 33. An LED module of claim 32, wherein said temperature sensing device is a thermistor.

34. An LED module of claim 31, wherein the output of said thermal sensitive amplifying circuit is input to said energy regulating circuit.

20 35. An LED module of claim 34, wherein said energy regulating circuit includes a microchip and a boosting circuit.

36. An LED module of claim 34, wherein said energy regulating circuit includes a microchip and a bucking circuit.

37. An LED module of claim 34, wherein said energy regulating circuit includes a microchip and an inverting circuit.

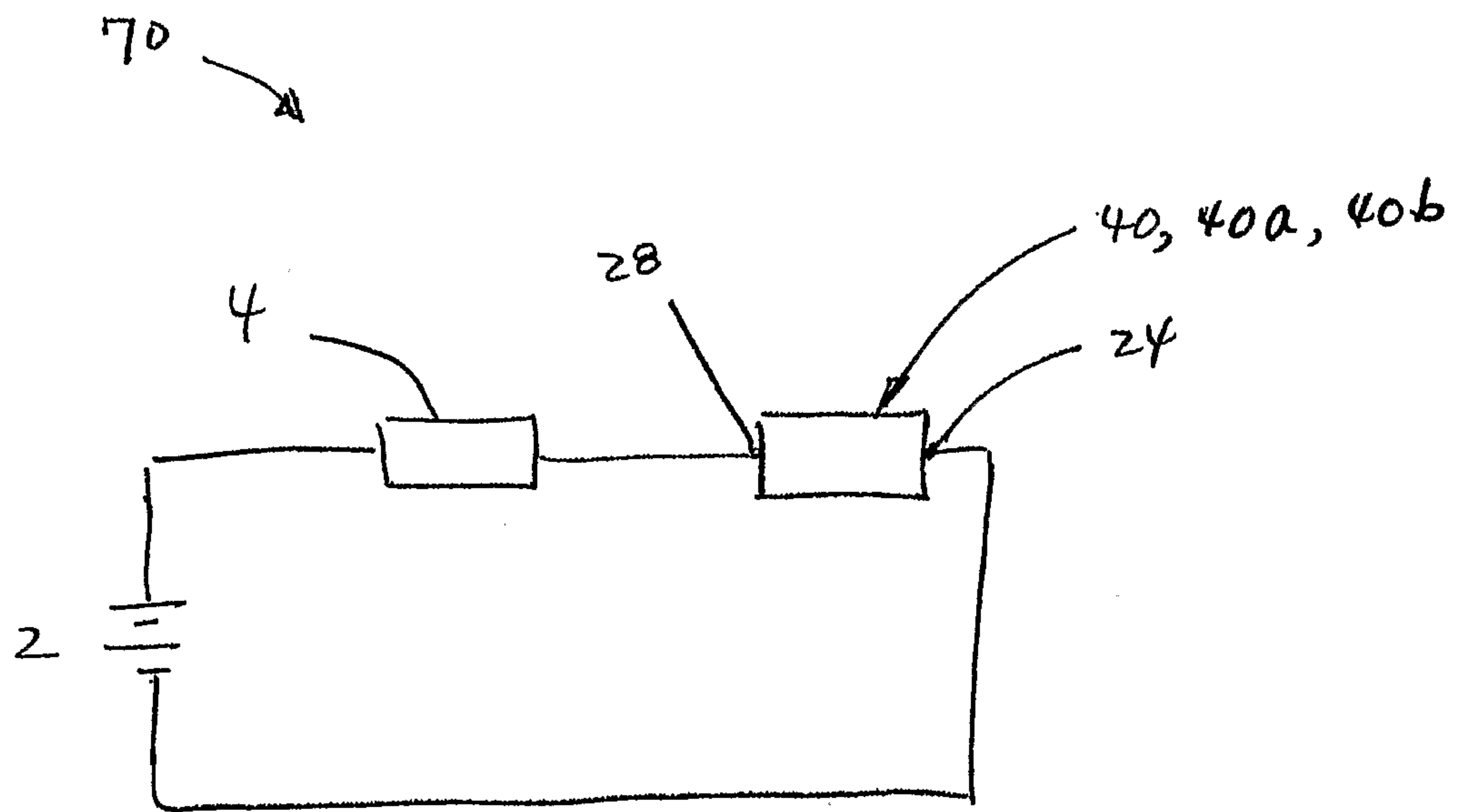


FIG. 1A

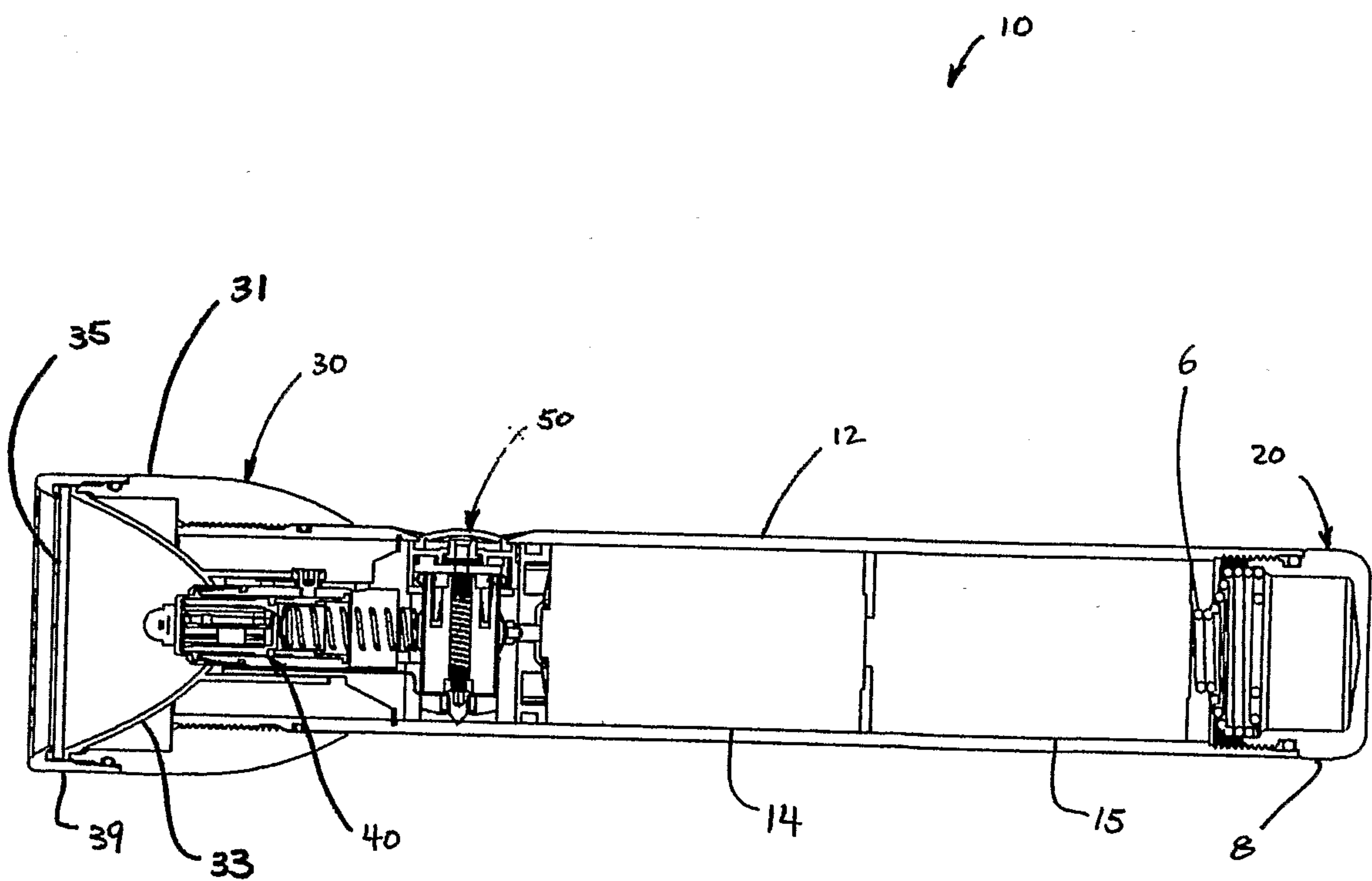


FIG. 1B

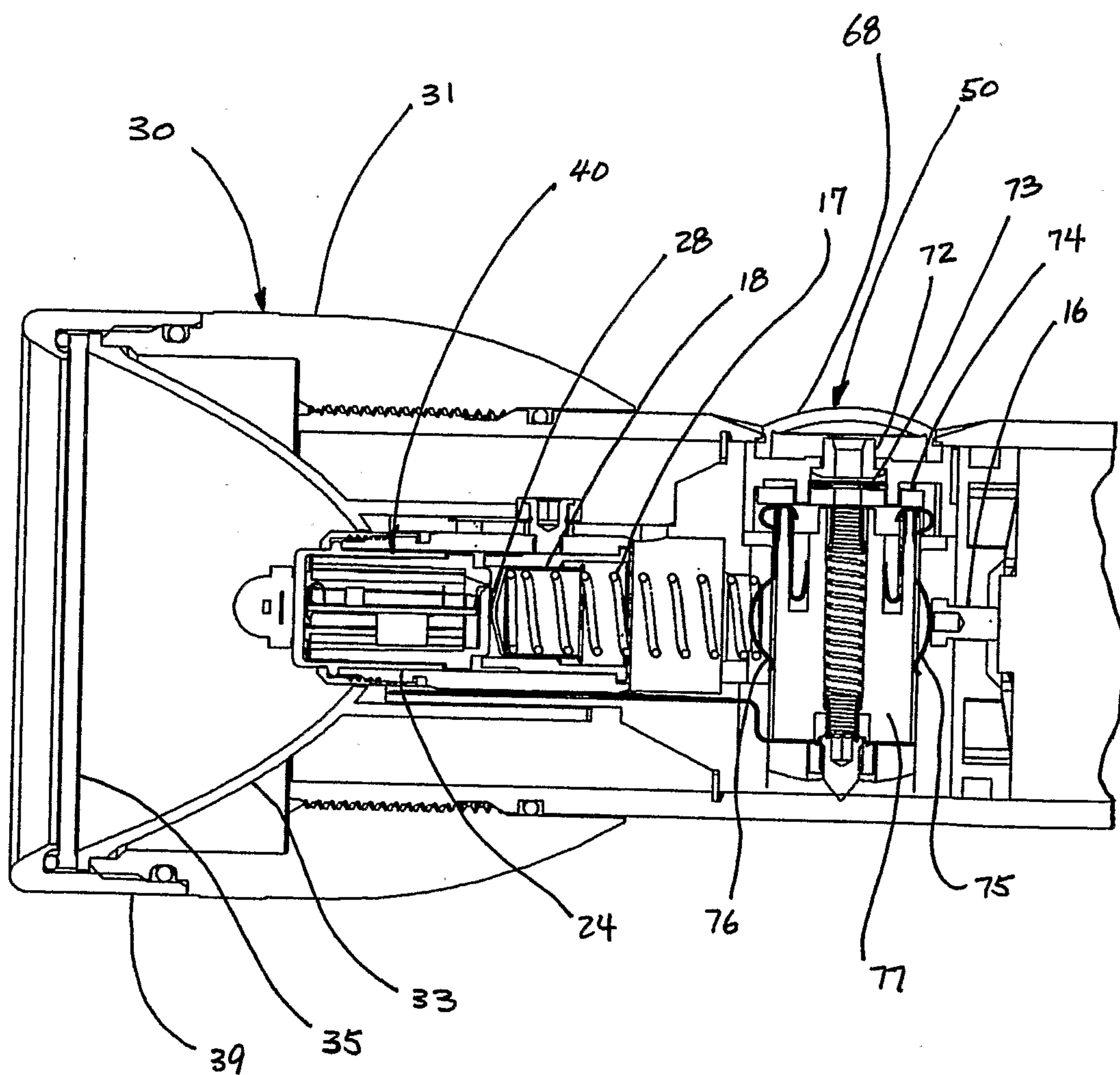


FIG. 2

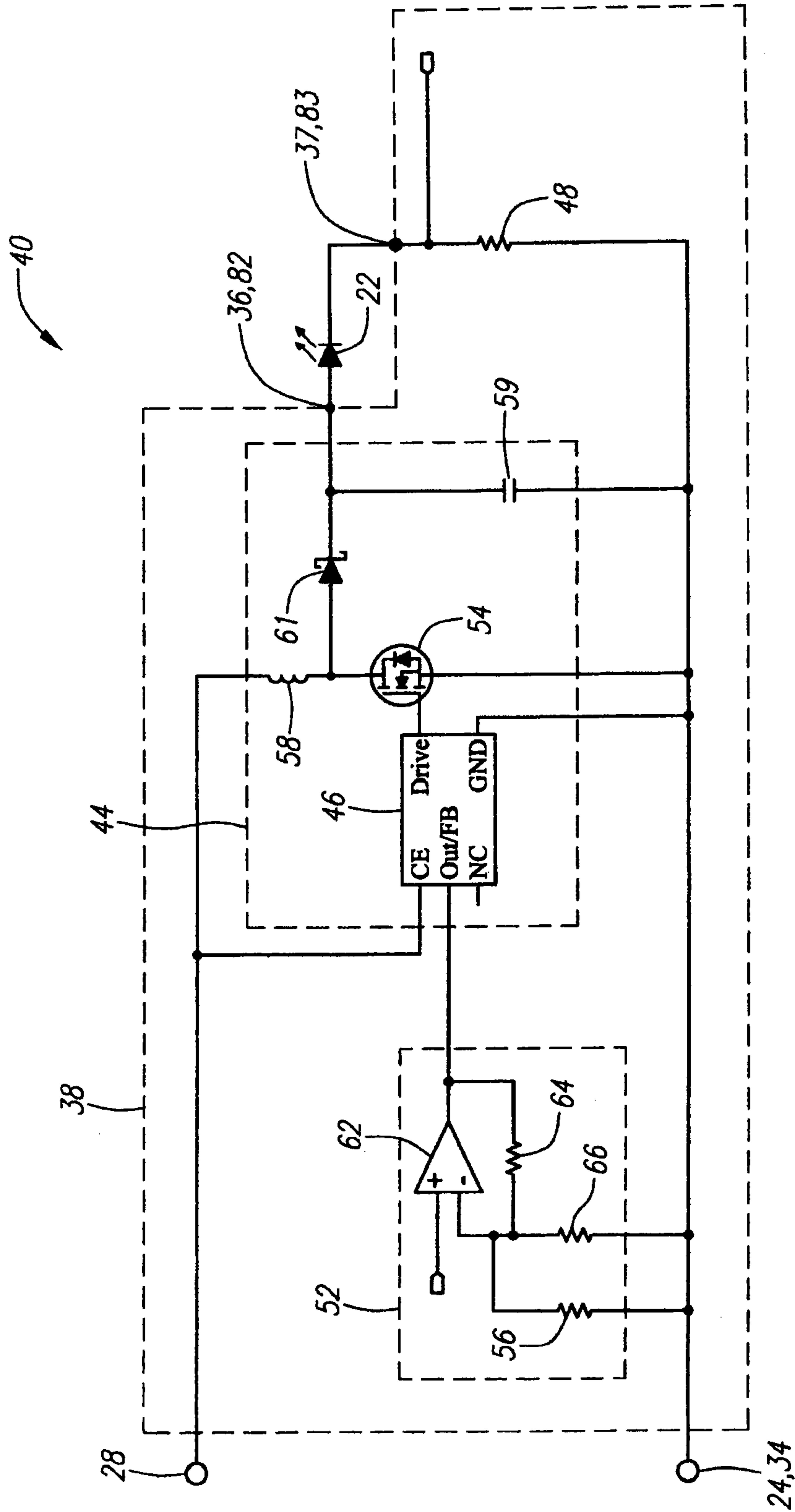


FIG. 3

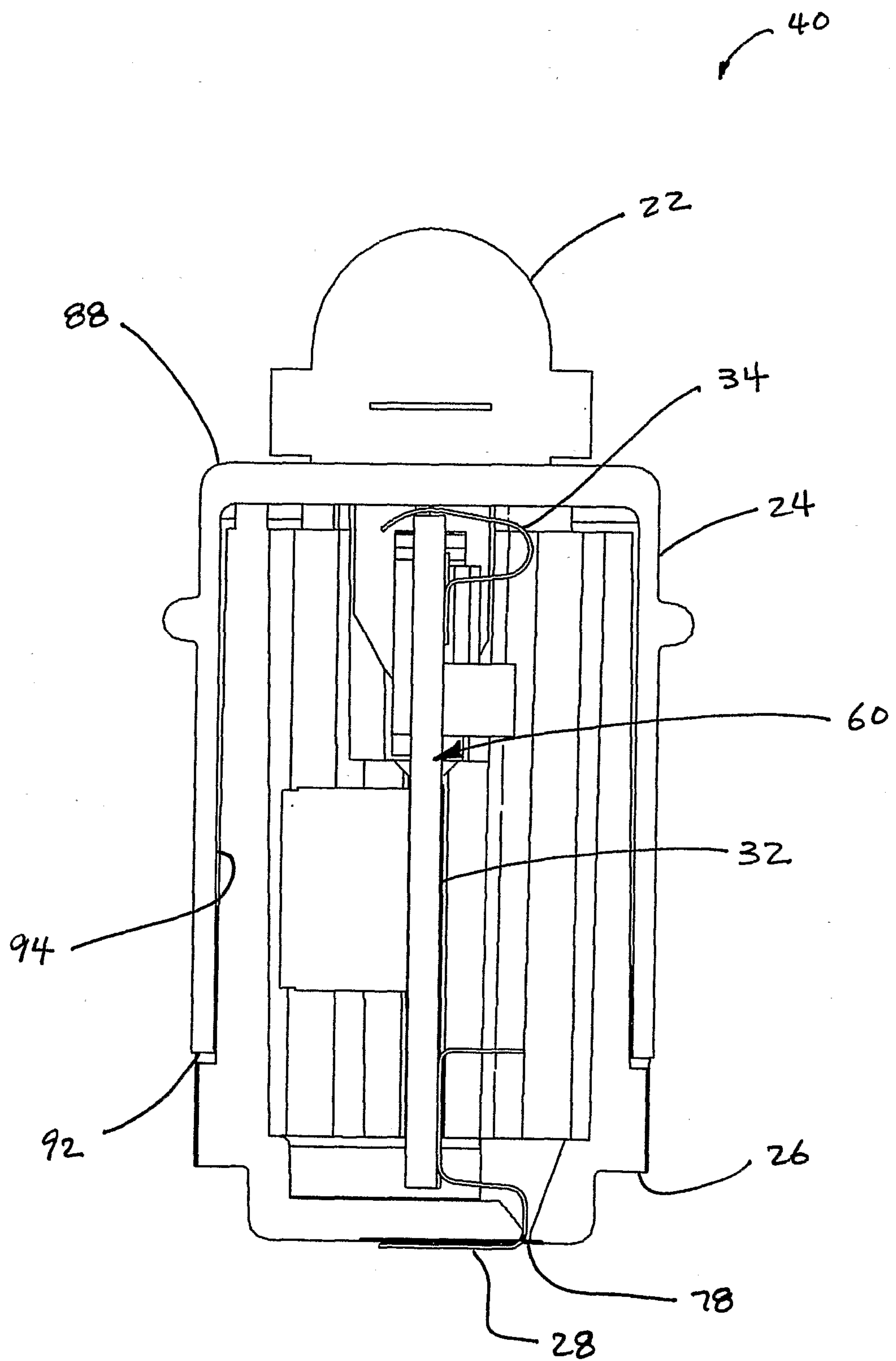


FIG. 4A

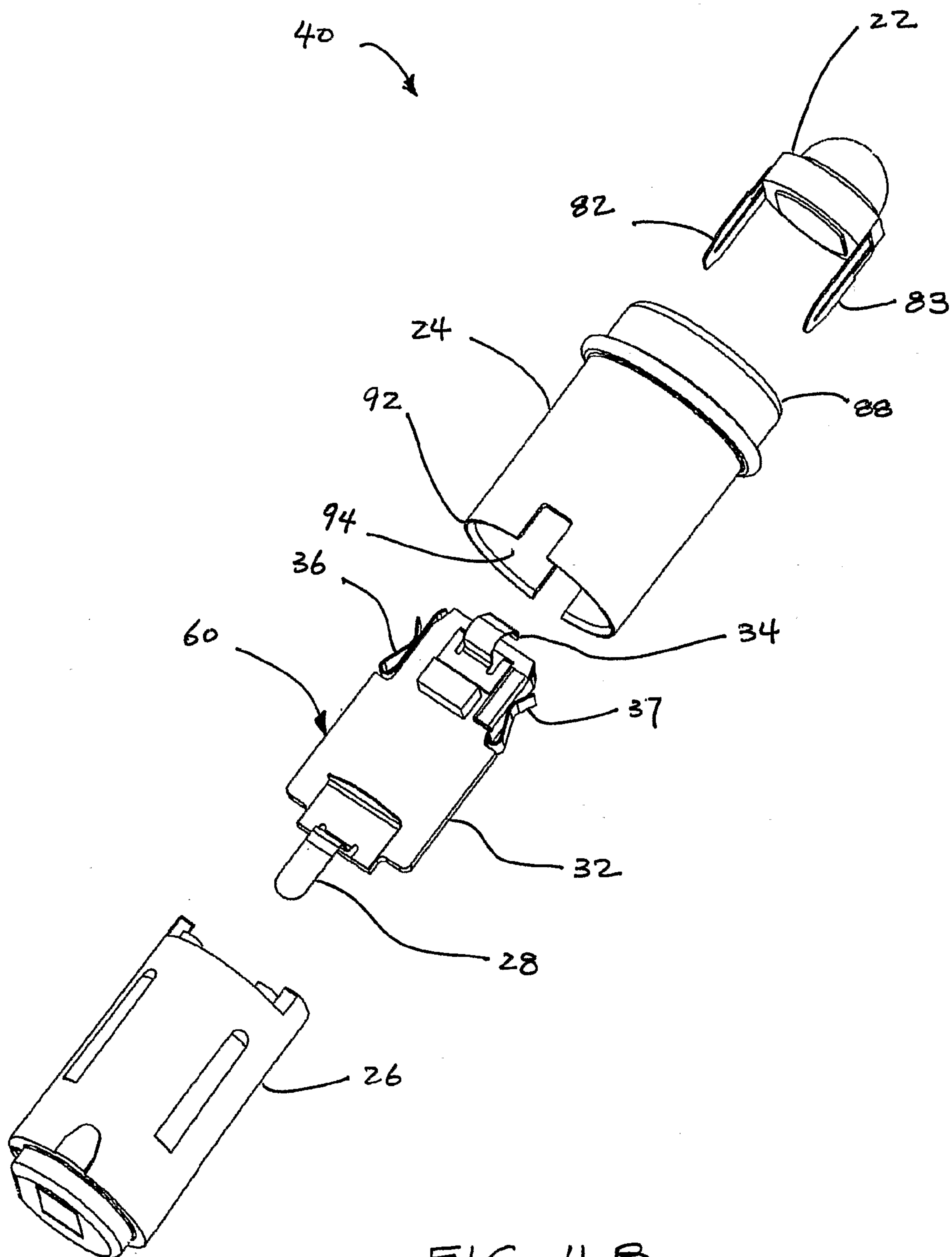


FIG. 4B

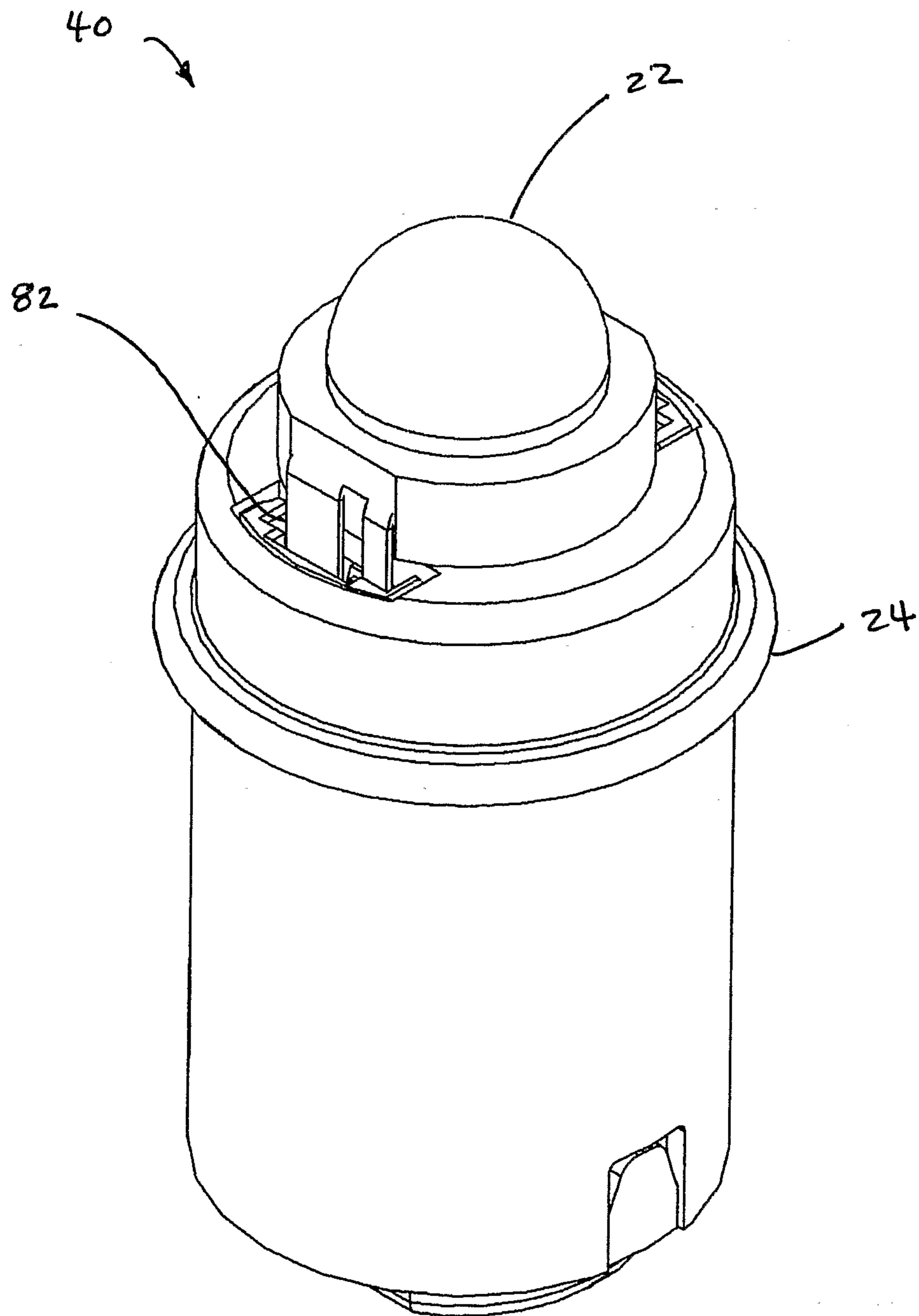


FIG. 4C





